

THYRISTOR MODULE

PHT308C

30A / 800V

FEATURES

- * Compatible with Isolated Base SOT227
- * Single Thyristor
- * High Surge Capability

TYPICAL APPLICATIONS

- * AC phase control

OUTLINE DRAWING

See the Next Page

Maximum Ratings

Approx Net Weight:35g

Parameter	Symbol	Grade	Unit
		PHT308C	
Repetitive Peak Off-State Voltage	V_{DRM}	800	V
Non Repetitive Peak Off-State Voltage	V_{DSM}	960	
Repetitive Peak Reverse Voltage	V_{RRM}	800	V
Non Repetitive Peak Reverse Voltage	V_{RSM}	960	

Parameter	Symbol	Conditions	Max Rated Value	Unit
Average Rectified Output Current *1	$I_{O(AV)}$	50Hz Half Sine Wave condition $T_c=T_o$ Be Determined	30	A
RMS On-State Current	$I_{T(RMS)}$		47	A
Surge Forward Current	I_{FSM}	50 Hz Half Sine Wave,1cycle Non-Repetitive	300	A
I Squared t	I^2t	2msec to 10msec	450	A ² s
Critical Rate of Turned-On Current	di/dt	$V_D=2/3V_{DRM}$, $I_{TM}=2 \cdot I_O$, $T_j=125^\circ C$ $I_G=200mA$, $di_G/dt=0.2A/\mu s$	100	A/ μs
Peak Gate Power	P_{GM}		5	W
Average Gate Power	$P_{G(AV)}$		1	W
Peak Gate Current	I_{GM}		2	A
Peak Gate Voltage	V_{GM}		10	V
Peak Gate Reverse Voltage	V_{RGM}		5	V
Operating JunctionTemperature Range	T_{jw}		-40 to +125	$^\circ C$
Storage Temperature Range	T_{stg}		-40 to +125	$^\circ C$
Isoration Voltage	Viso	Base Plate to Terminals, AC1min	2500	V
Mounting torque	Case mounting	Ftor	M4 Screw	N.m
	Terminals		M4 Screw	

Value per 1 Arm

Electrical • Thermal Characteristics

Characteristics	Symbol	Test Conditions	Maximum Value.			Unit
			Min.	Typ.	Max.	
Peak Off-State Current	I_{DM}	$V_{DM} = V_{DRM}, T_j = 125^\circ\text{C}$			10	mA
Peak Reverse Current	I_{RM}	$V_{RM} = V_{RRM}, T_j = 125^\circ\text{C}$			10	mA
Peak On-State Voltage	V_{TM}	$I_{TM} = 90\text{A}, T_j = 25^\circ\text{C}$			1.5	V
Gate Current to Trigger	I_{GT}	$V_D = 6\text{V}, I_T = 1\text{A}$	$T_j = -40^\circ\text{C}$		200	mA
			$T_j = 25^\circ\text{C}$		100	
			$T_j = 125^\circ\text{C}$		50	
Gate Voltage to Trigger	V_{GT}	$V_D = 6\text{V}, I_T = 1\text{A}$	$T_j = -40^\circ\text{C}$		4	V
			$T_j = 25^\circ\text{C}$		2.5	
			$T_j = 125^\circ\text{C}$		2	
Gate Non-Trigger Voltage	V_{GD}	$V_D = 2/3V_{DRM}, T_j = 125^\circ\text{C}$	0.25			V
Critical Rate of Rise of Off-State Voltage	dv/dt	$V_D = 2/3V_{DRM}, T_j = 125^\circ\text{C}$	500			V/ μs
Turn-Off Time	tq	$I_{TM} = I_O, V_D = 2/3V_{DRM}$ $dv/dt = 20\text{V}/\mu\text{s}, V_R = 100\text{V}$ $-di/dt = 20\text{A}/\mu\text{s}, T_j = 125^\circ\text{C}$		100		μs
Turn-On Time	tgt	$T_j = 25^\circ\text{C}, I_{TM} = I_{T(RMS)}$		6		μs
Delay Time	td	$V_D = 2/3V_{DRM}, I_G = 200\text{mA}$		2		μs
Rise Time	tr	$di_G/dt = 0.2\text{A}/\mu\text{s}$		4		μs
Latching Current	I_L	$T_j = 25^\circ\text{C}$		100		mA
Holding Current	I_H	$T_j = 25^\circ\text{C}$		50		
Thermal Resistance *1	Rth(j-c)	Junction to Case			1.33	$^\circ\text{C}/\text{W}$
	Rth(c-f)	Base Plate to Heat Sink with Thermal Compound			0.3	

Value Per 1Arm

*1: Value Per Module

PHT308C OUTLINE DRAWING (Dimensions in mm)

